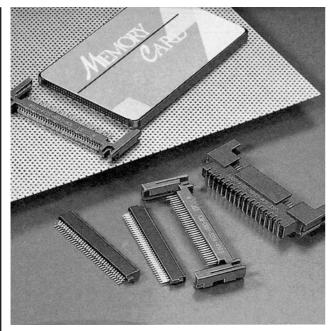


68-circuit PC card connectors

1.27mm



1.27 mm pitch 68-circuit connector for PC cards.

#### Features —

Header pins are designed to be protected against static electricity

#### • Easy inspection and touch-up after reflow soldering

The SMT type header is 0.635 mm pitch, with single row solder tails positioned so that inspection and touch-up after reflow soldering is easy.

#### Socket

Two mounting methods, dual row straddle type and in line SMT type with variation of PC board offset distance. Newly lined up springy grounding pin type socket provides easy but stable grounding circuit connection between PC board to metal section of card frame by springy No.1 and No.35 grounding pins.

#### • Applicable to low-voltage (3.3 V) card

Headers for type  $\mathbf{II}$  cards have a groove to be applicable to the low-voltage (3.3 V) cards.



Current rating: 0.5 A AC, DC/line
Temperature range: -40°C to +85°C

(including temperature rise in applying

electrical current)

• Contact resistance: Initial value/ 40 m $\Omega$  max.

After environmental tests/ 20 m $\Omega$  max.

(variation from initial value)

• Withstanding voltage: 500 VAC/minute

• Insulation resistance: 1,000 M $\Omega$  min. (Initial)

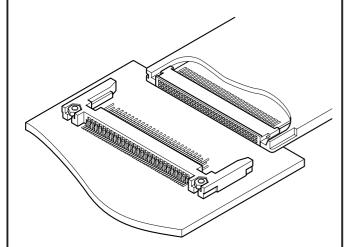
• Durability: 10,000 cycles

- \* Refer to "General Instruction and Notice when using Terminals and Connectors" at the end of this catalog.
- \* Contact JST for details.
- \* Compliant with RoHS.

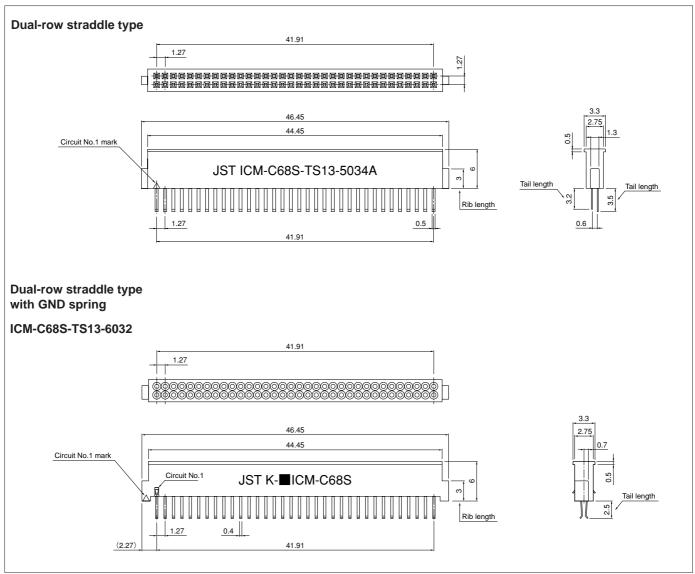
#### Standards -

Recognized E60389

Certified LR20812



#### Socket



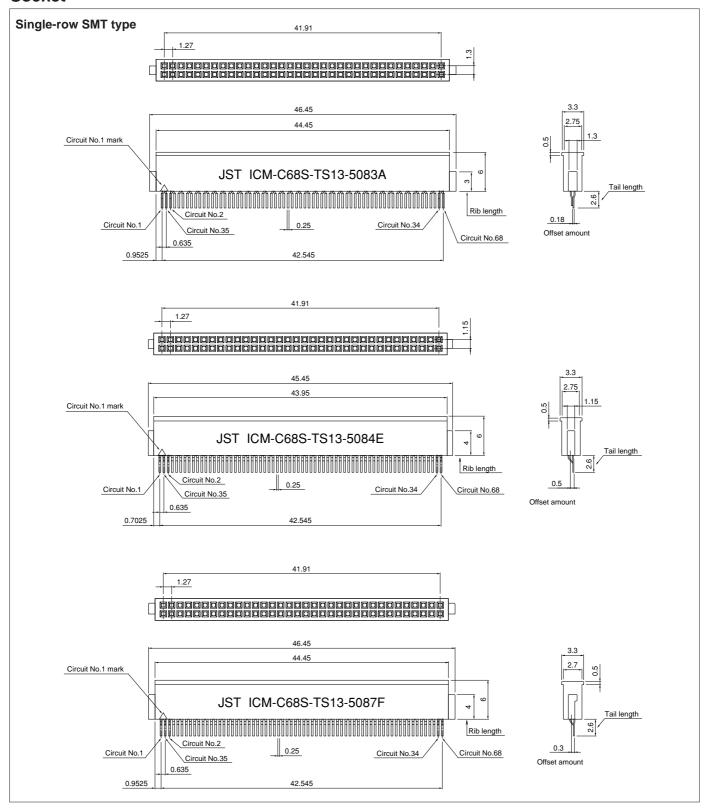
Circuits	Solder tail	GND spring	Offset dimensions		Tail length (mm)	Model No.	Q'ty/ box	Material and Finish
68	Dual-row straddle type	Without	Center	3.0	3.2, 3.5	ICM-C68S-TS13-5034A	480	Contact: Copper alloy, nickel-undercoated, Mating part; gold-plated Solder tail; tin-plated (reflow treatment) Housing: PA 6T, UL94V-0, black
00		With (Circuit No.1, No.35)	Center	3.0	2.5	ICM-C68S-TS13-6032	360	Contact: Copper alloy, nickel-undercoated, Mating part; gold-plated Housing: LPC, UL94V-0, black Grounding spring: Copper alloy, nickel-undercoated, gold-plated

RoHS compliance This product displays (LF)(SN) on a label.

Note: 1. ICM-C68S-TS13-5033A, ICM-C68S-TS13-5034A and ICM-C68S-TS13-5073A are not approved by UL/CSA.

2. ICM-C68S-TS13-6032 is not approved by CSA.

#### Socket



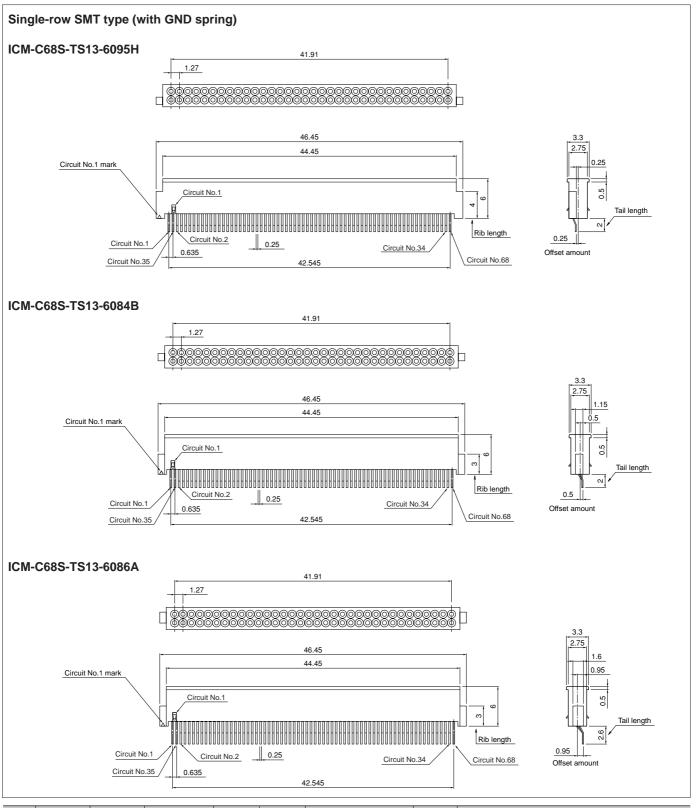
Circuits	Solder tail	GND spring	Offset dimensions (mm)		Tail length (mm)	Model No.	Q'ty	Material and Finish
	Single-row SMT type	Without	0.18	3.0	2.6	ICM-C68S-TS13-5083A	360/box	Contact: Copper alloy, nickel-undercoated,
68			0.5	4.0	2.6	ICM-C68S-TS13-5084ET	1,500/reel	Mating part; gold-plated Solder tail; tin-plated (reflow treatment)
			0.3	4.0	2.6	ICM-C68S-TS13-5087FT	1,500/reel	

RoHS compliance This product displays (LF)(SN) on a label.

Note: 1. ICM-C68S-TS13-5084ET & ICM-C68S-TS13-5087FT are supplied on embossed-tape.

2. Not UL/CSA approved.

#### Socket



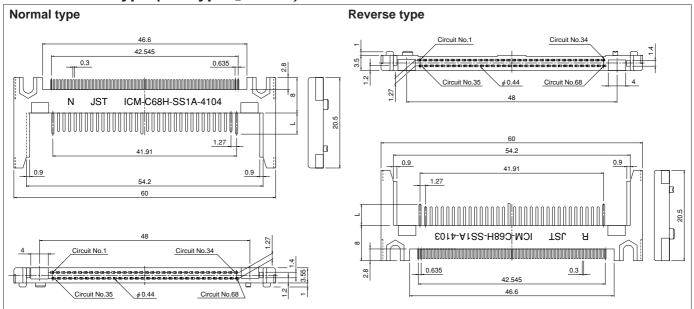
(	Circuits	Solder tail	GND spring	Offset dimensions (mm)		Tail length (mm)	Model No.	Q'ty/box (Note 1)	Material and Finish
_		Single-row SMT type with	e With (Circuit	0.25	4.0	2.0	ICM-C68S-TS13-6095H	360	Contact: Copper alloy, nickel-undercoated, Mating part; gold-plated Solder tail; tin-plated (reflow treatment)
	68			0.5	3.0	2.0	ICM-C68S-TS13-6084B	360	
_		GND spring	No.1, No.35)	0.95	3.0	2.6	ICM-C68S-TS13-6086A		Housing: LCP, UL94V-0, black Grounding spring: Copper alloy, nickel-undercoated, gold-plated

RoHS compliance This product displays (LF)(SN) on a label.

Note: 1. The products supplied on embossed-tape are also available.

2. Not UL/CSA approved.

### Header / SMT type (for Type I cards)



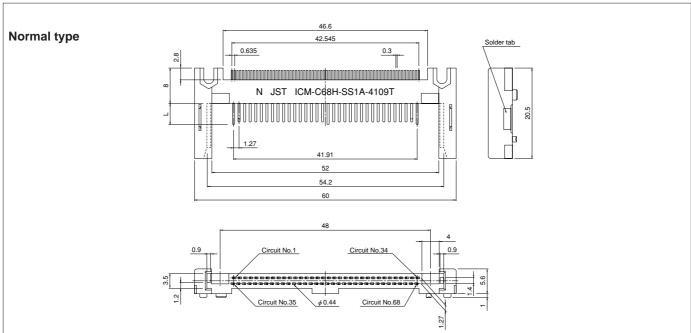
Circuits	Туре	Model No.	Q'ty/box	Material and Finish	
68	Normal	ormal ICM-C68H-SS1A-4104		Contact: Phosphor bronze, nickel-undercoated, Mating part; gold-plated	
	Reverse	Reverse ICM-C68H-SS1A-4103	110	Solder tail; tin-plated (reflow treatment) Housing: PPS, UL94V-0, natural	

RoHS compliance This product displays (LF)(SN) on a label.

#### Dimension L

Circuit No.	Dimensions (mm)			
1, 17, 34, 35, 51, 68	5.0 ±0.1			
2 to 16, 18 to 33,	4.25 +0.1			
37 to 50, 52 to 66	4.23 ±0.1			
36, 37	3.5 ±0.1			

### Header / SMT type (for Type <u>∏</u> cards)



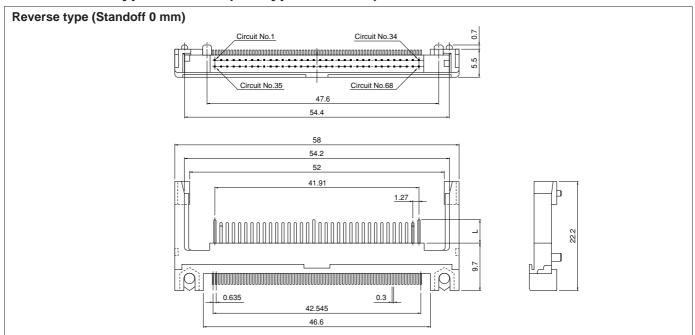
Circuits	Туре	Model No.	Q'ty/box	Material and Finish
68	Normal	ICM-C68H-SS1A-4109T	80	Contact: Phosphor bronze, nickel-undercoated, Mating part; gold-plated Solder tail; tin-plated (reflow treatment) Housing: PPS, UL94V-0, natural Solder tab: Phosphor bronze, copper-undercoated, tin-plated (reflow treatment)

RoHS compliance This product displays (LF)(SN) on a label.

#### Dimension L

Circuit No.	Dimensions (mm)			
1, 17, 34, 35, 51, 68	5.0 ±0.1			
2 to 16, 18 to 33,	4.25 +0.1			
37 to 50, 52 to 66	4.23 ±0.1			
36, 37	3.5 ±0.1			

### Header / SMT type for 3.3 V (for Type <u>I</u>II cards)-



Circuits	Туре	Model No.	Q'ty/box	Material and Finish
68	Reverse	ICM-C68H-S112-400R1	90	Contact: Phosphor bronze, nickel-undercoated, Mating part; gold-plated Solder tail; tin-plated (reflow treatment) Housing: PA 6T, UL94V-0, black

 Dimension L

 Circuit No.
 Dimensions (mm)

 1, 17, 34, 35, 51, 68
 5.0 ±0.1

 2 to 16, 18 to 33, 37 to 50, 52 to 66
 4.25 ±0.1

 36, 37
 3.5 ±0.1

RoHS compliance This product displays (LF)(SN) on a label. Not UL/CSA approved.

### PC board layout

#### Header/SMT type (for Type I, I cards) SMT type/Standoff 0 mm Type Ⅲ cards (Refer to Note 2 below 2- \phi 2.2 \big| 0 52.1<sup>±0.05</sup> 53.3<sup>±0.05</sup> 42.545<sup>±0.05</sup> 47.5<sup>±0.05</sup> $0.635^{\pm0.05}$ 42.545 ±0.05 2.48<sup>±0.05</sup> 3.5 ±0.05 0.635 ±0.05 0.35<sup>±0.035</sup> 2…¢2.2 (Pad width) ⊕′ 3±0.05 $12.9 \pm 0.05$ 2- φ 1.7 <sup>+0.1</sup> Circuit No.35 Circuit No.1 Circuit No.68 φ 1.9 <sup>+0.1</sup> φ 2.4 <sup>+0.1</sup> $2-\phi 1.35^{+0.1}_{0}$ 25.1<sup>±0.05</sup> 56<sup>±0.05</sup> 47.6 ±0.05 61 <sup>±0.05</sup> 54.4 <sup>±0.05</sup>

- Note: 1. The above figure is the figure viewed from the component side.
  - 2. This layout is applied to the headers Model Nos. ICM-C68H-SS1A-4103/-4104/-4108T/-4109T.
  - 3. Tolerances are non-cumulative:  $\pm 0.05$  mm for all centers.
  - 4. Hole dimensions differ according to the type of PC board and piercing method. The dimensions above should serve as a guideline. Contact JST for details.
- Note: 1. The above figure is the figure viewed from the component side.
  - 2. Tolerances are non-cumulative: ±0.05 mm for all centers.
  - Hole dimensions differ according to the type of PC board and piercing method. The dimensions above should serve as a guideline. Contact JST for details.